

July 2007

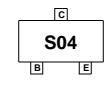


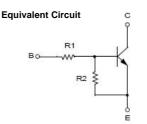
FJY3004R NPN Epitaxial Silicon Transistor

Features

- · Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R1=47KΩ, R2=47KΩ)
- Complement to FJY4004R







Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	50	V
V _{CEO}	Collector-Emitter Voltage	50	V
V _{EBO}	Emitter-Base Voltage	10	V
I _C	Collector Current	100	mA
T _{STG}	Storage Temperature Range	-55~150	۵°
TJ	Junction Temperature	150	°C
P _C	Collector Power Dissipation, by R _{0JA}	200	mW

These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

Thermal Characteristics* Ta=25°C unless otherwise noted

Symbol	Parameter	Мах	Units
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	600	°C/W

Minimum land pad size.

Electrical Characteristics* T_c = 25°C unless otherwise noted

Parameter	Test Condition	MIN	Тур	MAX	Units
Collector-Emitter Breakdown Voltage	Ic = 10 uA, IE = 0	50			V
Collector-Base Breakdown Voltage	Ic = 100 uA, I _B = 0	50			V
Collector-Cutoff Current	$V_{CB} = 40 V, I_E = 0$			0.1	uA
DC Current Gain	Vce = 5 V, Ic = 5 mA	56			
Collector-Emitter Saturation Voltage	Ic = 10 mA, I _B = 0.5 mA			0.3	V
Current Gain - Bandwidth Product	Vce = 10V, Ic = 5 mA		250		MHz
Output Capacitance	Vcb = 10 V, IE = 0, f = 1.0 MHz		3.7		pF
Input Off Voltage	Vce = 5 V, Ic = 100uA	0.5			V
Input On Voltage	Vce = 0.3V, Ic = 2mA			3	V
Input Resistor		32	47	62	KΩ
Resistor Ratio		0.9	1.0	1.1	
	Collector-Emitter Breakdown Voltage Collector-Base Breakdown Voltage Collector-Cutoff Current DC Current Gain Collector-Emitter Saturation Voltage Current Gain - Bandwidth Product Output Capacitance Input Off Voltage Input On Voltage Input Resistor	Collector-Emitter Breakdown VoltageIc = 10 uA, IE = 0Collector-Base Breakdown VoltageIc = 100 uA, IB = 0Collector-Cutoff CurrentVcB = 40 V, IE = 0DC Current GainVcE = 5 V, Ic = 5 mACollector-Emitter Saturation VoltageIc = 10 mA, IB = 0.5 mACurrent Gain - Bandwidth ProductVcE = 10V, Ic = 5 mAOutput CapacitanceVcB = 10 V, IE = 0, f = 1.0 MHzInput Off VoltageVcE = 5 V, Ic = 100uAInput On VoltageVcE = 0.3V, Ic = 2mAInput ResistorVcE = 0.3V, Ic = 2mA	Collector-Emitter Breakdown VoltageIc = 10 uA, IE = 050Collector-Base Breakdown VoltageIc = 10 uA, IE = 050Collector-Cutoff CurrentVcB = 40 V, IE = 050DC Current GainVcE = 5 V, Ic = 5 mA56Collector-Emitter Saturation VoltageIc = 10 mA, IB = 0.5 mA56Current Gain - Bandwidth ProductVcE = 10V, Ic = 5 mA56Output CapacitanceVcB = 10 V, IE = 0, f = 1.0 MHz0.5Input Off VoltageVcE = 5 V, Ic = 100uA0.5Input On VoltageVcE = 0.3V, Ic = 2mA32	Collector-Emitter Breakdown VoltageIc = 10 uA, IE = 050Collector-Base Breakdown VoltageIc = 100 uA, IB = 050Collector-Cutoff CurrentVcB = 40 V, IE = 050DC Current GainVcE = 5 V, Ic = 5 mA56Collector-Emitter Saturation VoltageIc = 10 mA, IB = 0.5 mA56Current Gain - Bandwidth ProductVcE = 10V, Ic = 5 mA250Output CapacitanceVcB = 10 V, IE = 0, f = 1.0 MHz3.7Input Off VoltageVcE = 5 V, Ic = 100uA0.5Input On VoltageVcE = 0.3V, Ic = 2mA32	Collector-Emitter Breakdown VoltageIc = 10 uA, IE = 050Collector-Base Breakdown VoltageIc = 10 uA, IB = 050Collector-Cutoff CurrentVcB = 40 V, IE = 00.1DC Current GainVcE = 5 V, Ic = 5 mA56Collector-Emitter Saturation VoltageIc = 10 mA, IB = 0.5 mA0.3Current Gain - Bandwidth ProductVcE = 10V, Ic = 5 mA250Output CapacitanceVcB = 10 V, IE = 0, f = 1.0 MHz3.7Input Off VoltageVcE = 5 V, Ic = 100uA0.5Input On VoltageVcE = 0.3V, Ic = 2mA3Input Resistor3247

Typical Performance Characteristics

Figure 1. DC current Gain

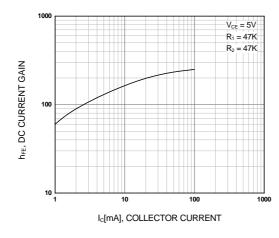


Figure 2. Input On Voltage

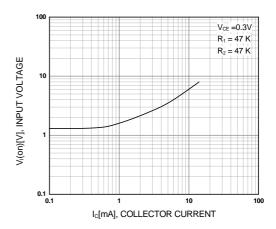
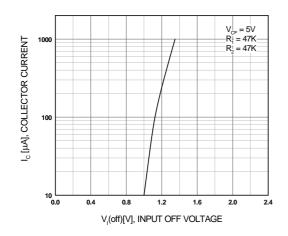
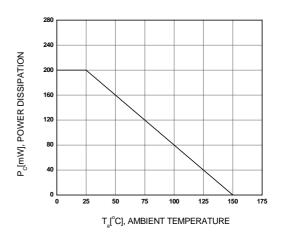
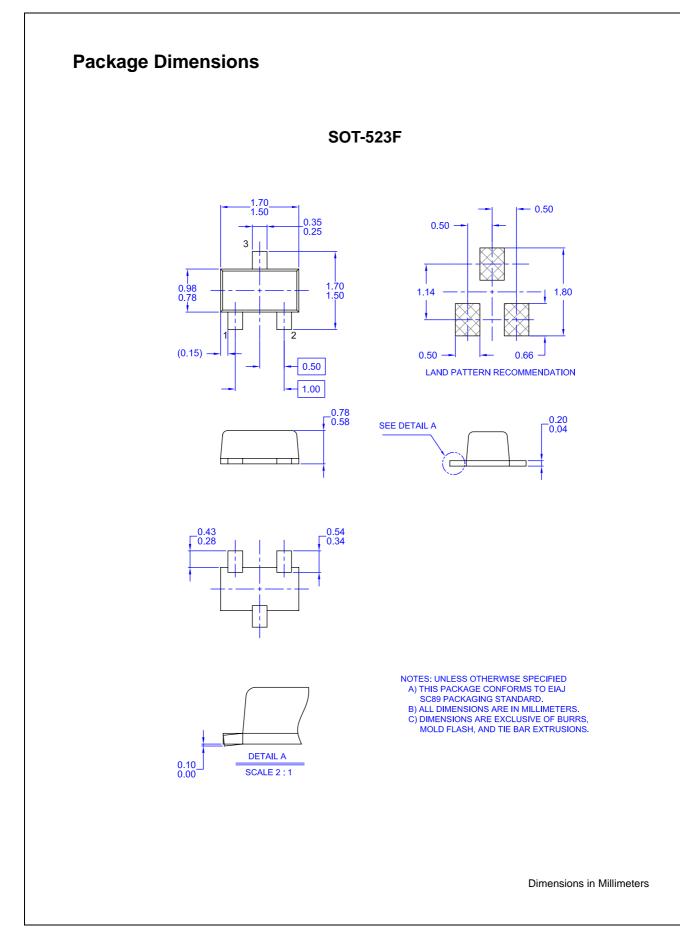


Figure 3. Input off Voltage









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